

Vishay Siliconix

P-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	-30					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.045					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5$ V	0.075					
Q _g typ. (nC)	13.6					
I _D (A) a,e	-4.6					
Configuration	Single					

FEATURES

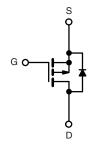
- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- · Load switch
- · Notebook adaptor switch
- DC/DC converter



P-Channel MOSFET

ORDERING INFORMATION	
Package	SOT-23 (TO-236)
Lead (Pb)-free and halogen-free	Si2343CDS-T1-GE3
Alternate manufacturing location	Si2343CDS-T1-BE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, u		SYMBOL	LIMIT	UNIT
PARAMETER		STINIDOL		UNIT
Drain-source voltage		V_{DS}	-30	V
Gate-source voltage		V_{GS}	±20	v
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-5.9	
	T _C = 70 °C		-4.7	
	T _A = 25 °C	I _D	-4.2 b, c	
	T _A = 70 °C		-3.3 b, c	Α
Pulsed drain current		I _{DM}	-25	
Continous source-drain diode current	T _C = 25 °C		-2.1	
	T _A = 25 °C	I _S	-1 ^{b, c}	
Maximum power dissipation	T _C = 25 °C		2.5	
	T _C = 70 °C	_	1.6	14/
	T _A = 25 °C	P _D	1.25 ^{b, c}	W
	T _A = 70 °C		0.8 b, c	
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R_{thJA}	75	100	°C/W	
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	40	50	C/VV	

Notes

- a. Based on T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 166 °C/W
- e. Package limited

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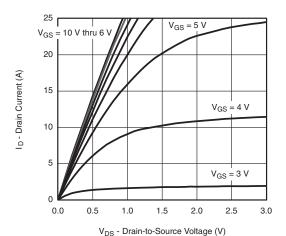
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	•	•
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	-30	-	-	V
VDS temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-19	-	mV/°C
VGS(th) temperature coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = - 250 μA	-	4.4	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	-1.2	-	- 2.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	±100	nA
7		V _{DS} = - 30 V, V _{GS} = 0 V	-	-	-1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-5	
On-state drain current a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-25	-	-	Α
D		V _{GS} = - 10 V, I _D = - 4.2 A	-	0.037	0.045	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.2 A	-	0.062	0.075	
Forward transconductance a	9 _{fs}	V _{DS} = - 15 V, I _D = - 4.2 A	-	10	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	590	-	
Output capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz	-	115	-	pF
Reverse transfer capacitance	C _{rss}	1	-	93	-	
	Q_g	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 4.2 A	-	13.6	21	
Total gate charge			-	7	11	
Gate-source charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.2 \text{ A}$	-	2.3	-	nC
Gate-drain charge	Q _{gd}	1	-	3.2	-	1
Gate resistance	Rq	f = 1 MHz	1	5	10	Ω
Turn-on delaytime	t _{d(on)}		-	30	45	
Rise time	t _r	$V_{DD} = -15 \text{ V}, R_1 = 4.5 \Omega$	-	25	38	1
Turn-off delay time	t _{d(off)}	$I_D \cong$ - 3.3 A, $V_{GEN} =$ - 4.5 V, $R_g =$ 1 Ω	-	16	24	1
Fall time	t _f	1	-	8	16	
Turn-on delay time	t _{d(on)}		-	8	16	ns
Rise time	t _r	V _{DD} = - 15 V, R _I = 4.5 Ω	-	10	20	
Turn-off delay time	t _{d(off)}	$I_D \cong -3.3 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	18	27	
Fall time	t _f	1	-	8	16	
Drain-source body diode characteristic	s			•	•	•
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-4.2	
Pulse diode forward current	I _{SM}		-	-	-25	A
Body diode voltage	V_{SD}	I _S = - 3.3 A, V _{GS} = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t _{rr}		-	17	26	ns
Body diode reverse recovery charge	Q _{rr}	1	-	9	18	nC
Reverse recovery fall time	t _a	$I_F = -3.3 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$	-	10	-	
Reverse recovery rise time	t _b	1	-	7	-	ns

Notes

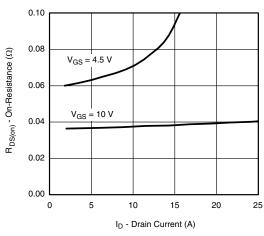
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

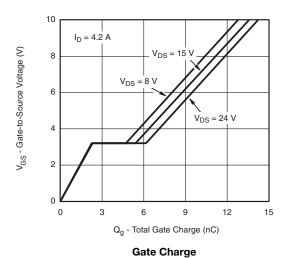


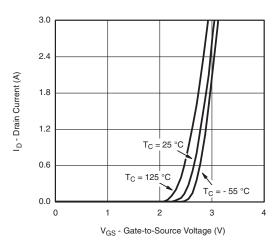


Output Characteristics

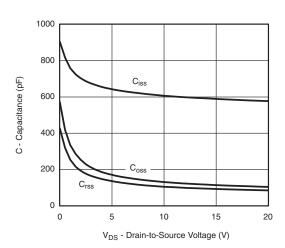


On-Resistance vs. Drain Current

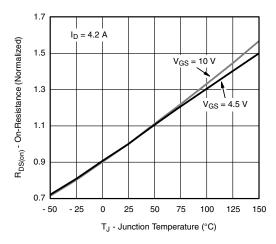




Transfer Characteristics

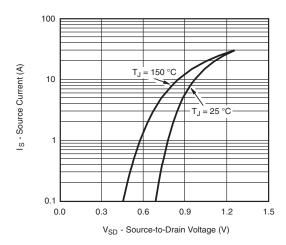


Capacitance

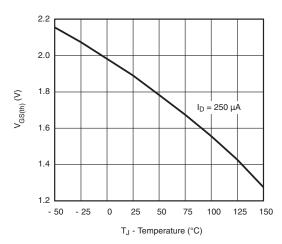


On-Resistance vs. Junction Temperature

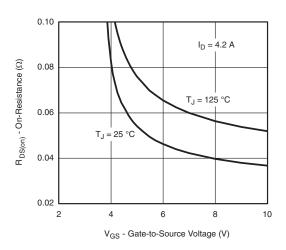




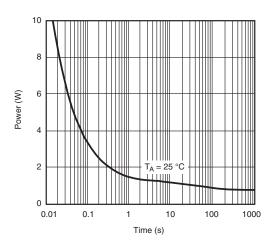
Source-Drain Diode Forward Voltage



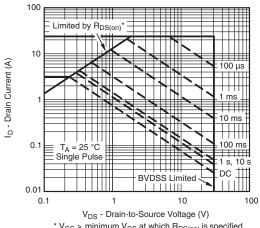
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



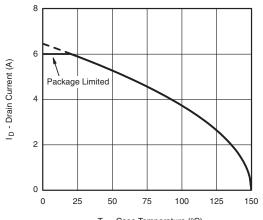
Single Pulse Power (Junction-to-Ambient)



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

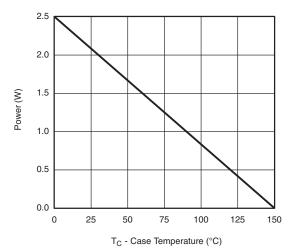
Safe Operating Area, Junction-to-Ambient

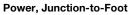


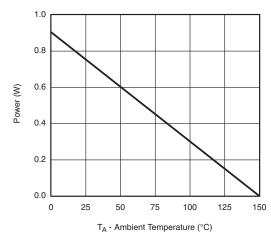


$T_{\mbox{\scriptsize C}}$ - Case Temperature (°C)

Current Derating*





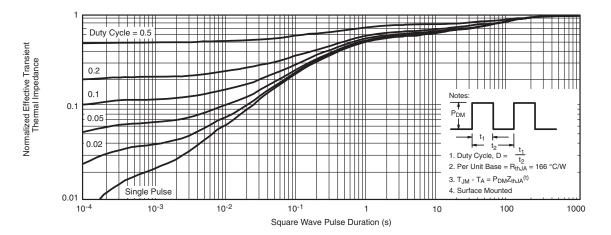


Power, Junction-to-Ambient

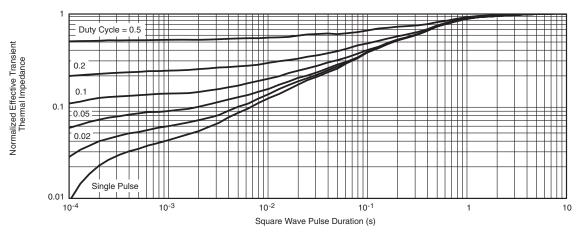
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

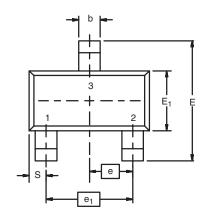


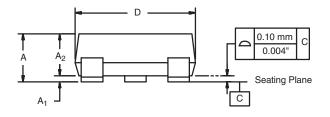
Normalized Thermal Transient Impedance, Junction-to-Foot

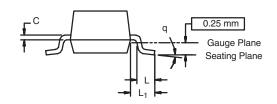
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SOT-23 (TO-236): 3-LEAD







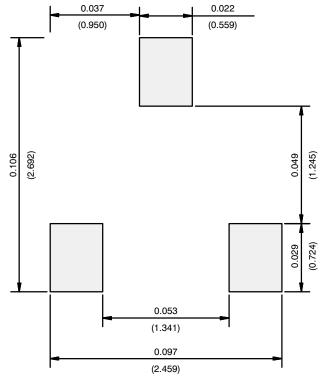
Dim	MILLIN	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.64 Ref 0.025 Ref		i Ref
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K. 09-	Jul-01				

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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